

All-MOCVD 980nm laser on (001) silicon

Continuous wave 980nm lasers grown on silicon by MOCVD show potential for application in optical fiber and IP network communication systems.

Hong Kong University of Science and Technology and the Chinese University of Hong Kong have reported continuous wave (CW) 980nm laser operation from structures grown on silicon (Si) by metal-organic chemical vapor deposition (MOCVD) [Qi Lin et al, Optics Express, v31, p15326, 2023]. The team used indium gallium arsenide phosphide (InGaAsP) layers for the quantum wells (QWs), and aluminium gallium arsenide (AlGaAs) for the barriers and cladding.

The researchers see the 980nm wavelength as having potential for optical fiber communication and internet protocol network systems. In particular, 980nm light can be used to pump erbium-doped fiber amplifiers (EDFAs).

The laser structure (Figure 1) was grown on (001) silicon, as used in mainstream complementary metal-oxide-semiconductor (CMOS) electronics manufacturing. The epitaxial growth was through MOCVD in

two reaction chambers for the GaAs template and for the laser structure.

The first growth was of the GaAs template layer, which included InGaAs/GaAs strained-layer superlattices (SLSs) to filter threading dislocations (TDs). Thermal cyclic annealing (TCA) was carried out before the SLS to improve the quality of the initial 1 μ m GaAs layer. The complete template layer was 2 μ m thick with the 2.8 \times 10⁷/cm² TD density.

The laser structure was grown in the second reaction chamber with strain-compensated InGaAs/GaAs/GaAsP quantum wells. The PL emission peak was at 956nm. A reference structure grown on GaAs substrate had a PL peak at the same wavelength.

The epitaxial material was fabricated into ridge-waveguide edge-emitting laser diodes (LDs). The n- and p-electrodes were titanium/platinum/gold and germanium/gold/nickel/gold, respectively. Passivation was provided by silicon dioxide. The material

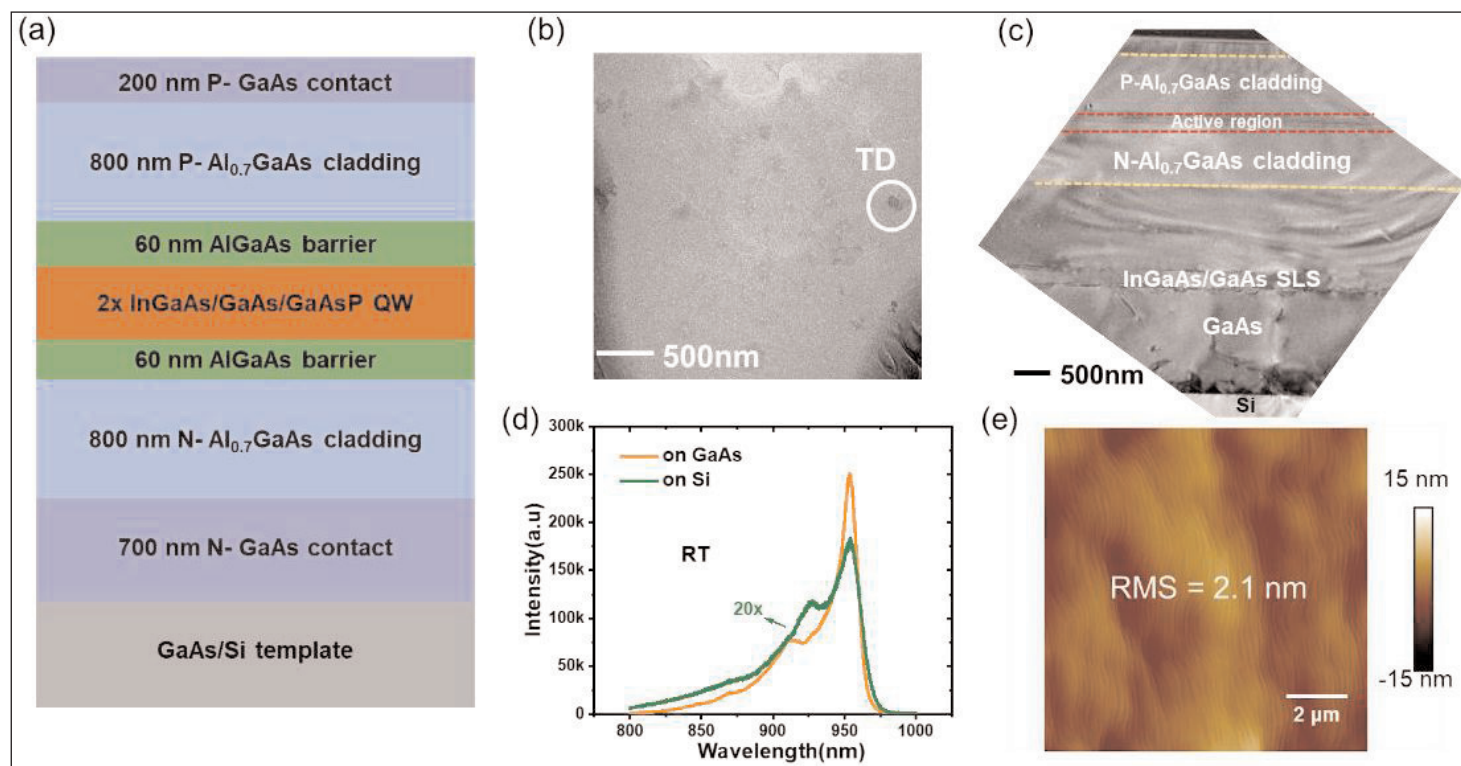


Figure 1. (a) Schematic of 980nm InGaAs/GaAs/GaAsP QW laser grown on GaAs/Si template; (b) Plan-view transmission electron microscope (TEM) images of 2 μ m-thick GaAs/Si template; (c) Global view cross-sectional TEM image of laser structure; (d) Room temperature (RT) μ -photoluminescence (PL) of structure; (e) Atomic force microscope image.

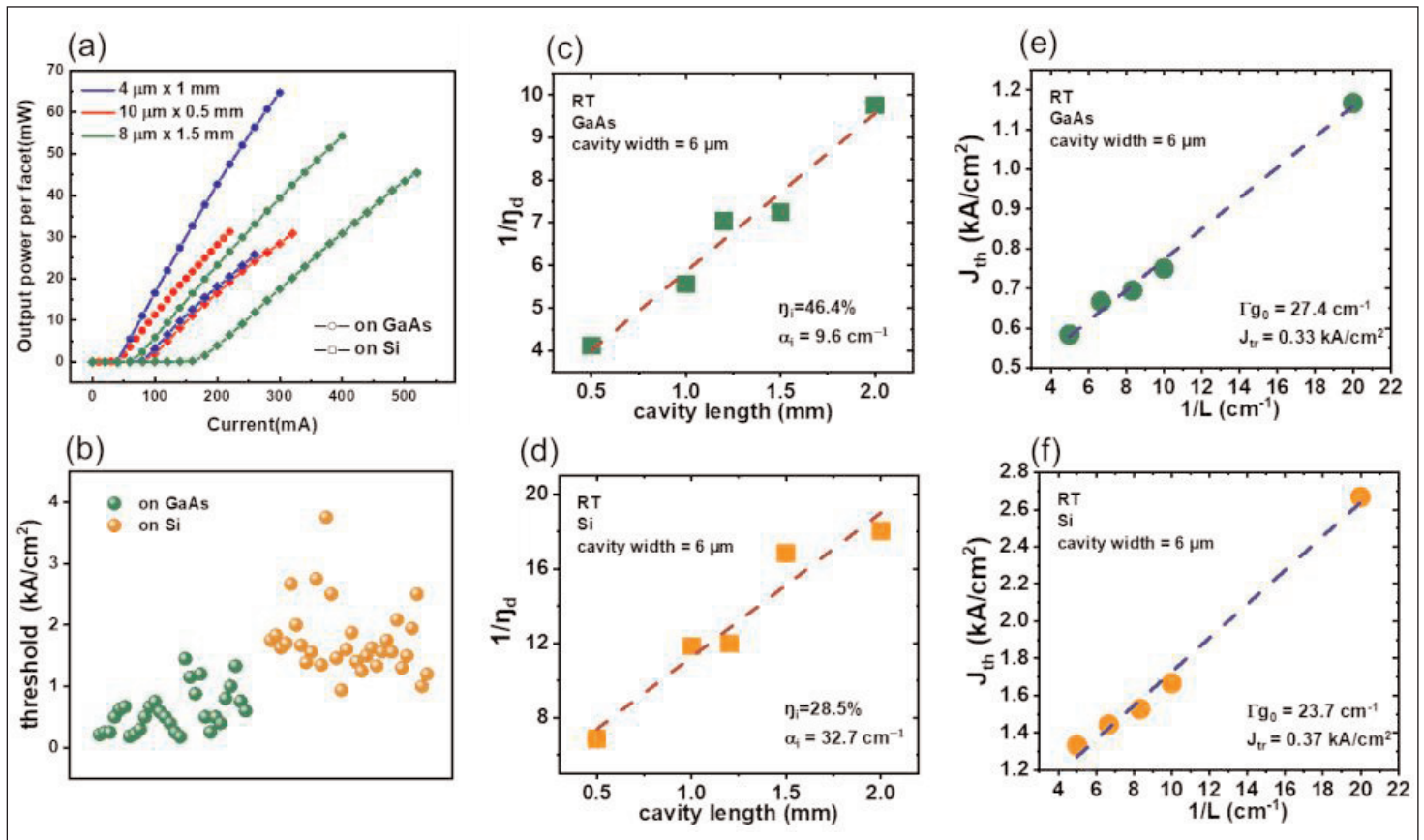


Figure 2. (a) Output power-current curves of InGaAs/GaAs/GaAsP QW lasers with various cavity size grown on GaAs and silicon; (b) threshold density distribution; extractions of (c) (d) internal quantum efficiency (IQE η_i), internal loss (α_i), (e) (f) modal gain (Γ_{g_0}) and transparency current density (J_{tr}), from cavity-length-dependent measurement.

was thinned to 100 μm and cleaved into laser bars without facet coatings. The CW measurements were made with the laser diodes mounted on temperature-controlled heatsinks.

The lowest lasing threshold current, 40 mA, was achieved on a 2 μm x 1 mm laser diode (Figure 2). The lowest threshold current density was 938 A/cm² on a 40 μm x 1.2 mm laser diode. This compares with a reference 70 μm x 2 mm device on GaAs that demonstrated a lower 179 A/cm² threshold.

The CW threshold on silicon is a little higher than the 867 A/cm² reported last year (see Semiconductor Today news, 2022) for a 980 nm laser diode on silicon grown by MOCVD (GaAs template) and molecular beam epitaxy (laser) at Beijing University of Posts and Telecommunications. The Beijing device was pretty short-lived at 12 minutes. The Hong Kong team does not report on the endurance of its laser diodes, although the Beijing life-time is considered “unacceptably short”.

The team comments: “Initial results show that the average threshold current density of the ridge-waveguide lasers on silicon (~1.91 kA/cm²), is approximately five times higher than devices on the native GaAs substrate (~410 A/cm²).”

The single-facet output power reached 46.4 mW on silicon, compared with 65 mW on GaAs substrate.

The greater spread in threshold current density and other laser diode performance limitations on silicon are tentatively attributed to the poorer quality of the GaAs template layer in comparison with what is achievable on native GaAs substrates. The poorer-quality template layer affects the QW uniformity, for example.

The researchers comment: “Based on the investigation of the internal parameters, a better laser performance with lower non-radiative losses can be achieved by further reducing the defects density of the GaAs film grown on silicon substrate via additional dislocation reduction approaches. In addition, laser performance improvement could also be achieved by enhancing the quality of QWs through optimization of parameters including the QW thickness and indium composition.”

The laser diodes on silicon were capable of lasing beyond the 95 °C limit of the measurement equipment. The characteristic temperature (T_0) scale for the shift to higher thresholds was 71.8 K, average. The T_0 for the reference devices on native GaAs was 139.1 K. The maximum values were 157 K (10 μm x 0.5 mm) and 84 K (2 μm x 1.5 mm) for laser diodes on GaAs and silicon, respectively. ■

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